

# FH30120GS

## N-Channel Trench Power MOSFET

### Description

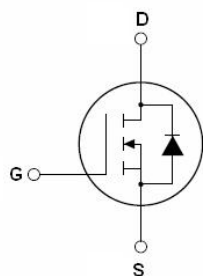
The FH30120GS uses advanced Shielded Gate trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### Application

- Motor drivers
- Power switching application
- DC/DC Converters In Computing
- Isolated DC/DC Converters In Telecom and Industrial

### Features

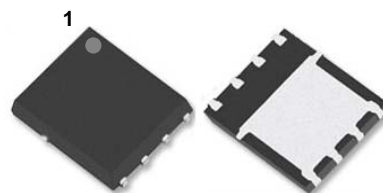
- $V_{DS} = 30V$  ;  $I_D = 120A$   
 $R_{DS(ON)}(Typ.) = 1.0 m\Omega @ V_{GS} = 10 V$   
 $R_{DS(ON)}(Typ.) = 1.6 m\Omega @ V_{GS} = 4.5V$
- High density cell design for ultra low  $R_{dson}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation



Schematic diagram



Marking and pin Assignment



PDFN5x6-8L top and bottom view

### Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise specified)

Symbol	Parameter	Max.	Units
$V_{DSS}$	Drain-Source Voltage	30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$I_D^*$	Continuous Drain Current	$T_C = 25^\circ C$	120
		$T_C = 100^\circ C$	68
$I_{DM}^{*****}$	Pulsed Drain Current	314	A
$E_{AS}^{****}$	Single Pulsed Avalanche Energy	128	mJ
$P_D^*$	Power Dissipation	$T_C = 25^\circ C$	34
$R_{\theta JC}^*$	Thermal Resistance, Junction to Case	3.2	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ C$

#### Notes :

- \* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10$  sec
- \*\* Pulse width  $\leq 300 \mu s$ , duty cycle  $\leq 2\%$
- \*\*\* limited by bonding wire
- \*\*\*\*  $V_D=20V, V_G=10V, R_G=25\Omega, L=0.5mH$

**Electrical Characteristics** ( $T_c=25^\circ\text{C}$  unless otherwise specified)

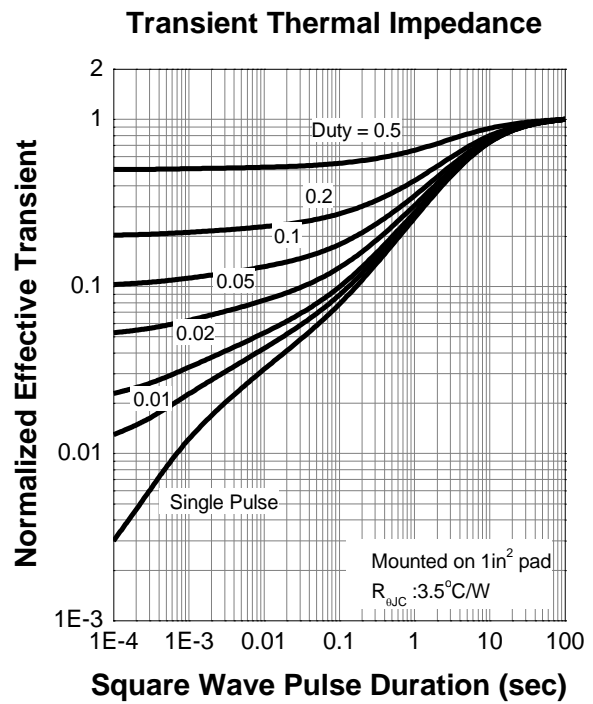
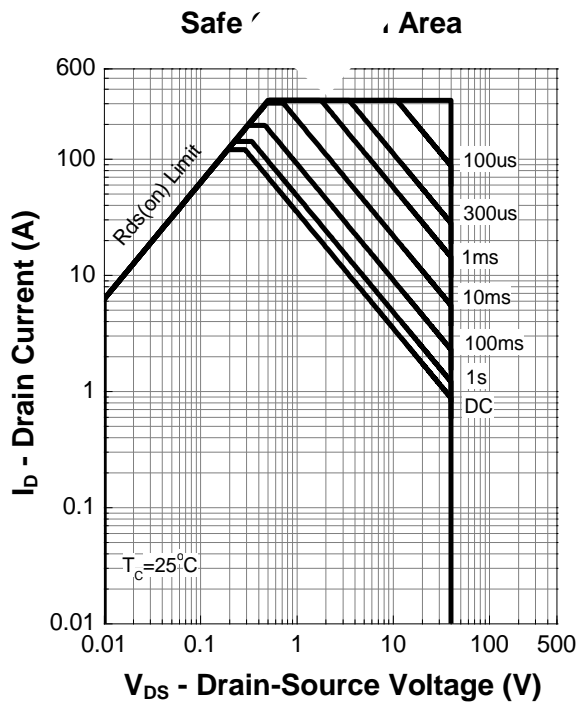
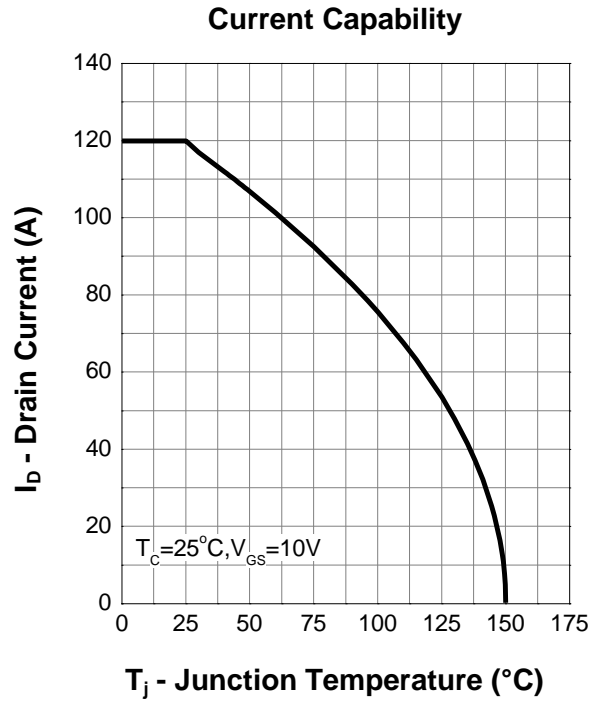
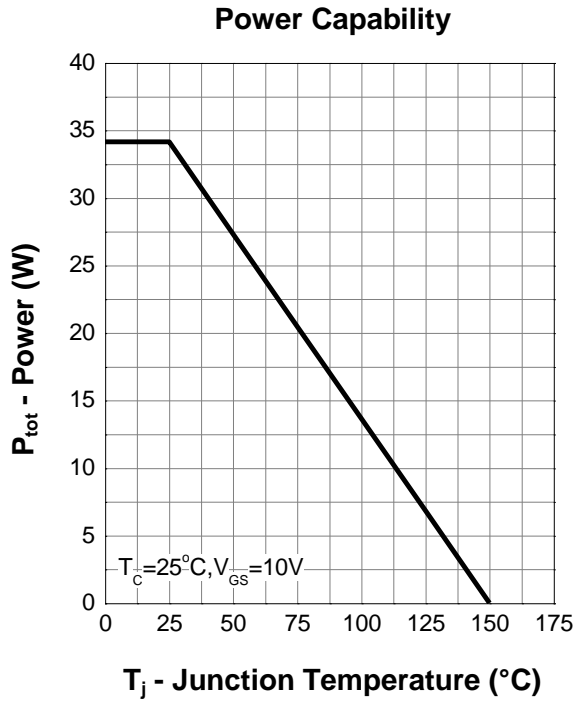
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=30V, V_{GS}=0V,$	-	-	1.0	$\mu A$
$I_{GSS}$	Gate to Body Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.8	2.5	V
$R_{DS(on)}^a$	Static Drain-Source on-Resistance	$V_{GS}=10V, I_D=20A$	-	1.0	1.4	m $\Omega$
		$V_{GS}=4.5V, I_D=10A$	-	1.6	2.0	
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=10A$	-	15.5	-	S
<b>Dynamic Characteristics</b> <sup>b</sup>						
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V,$ $f=1.0MHz$	-	3930	-	pF
$C_{oss}$	Output Capacitance		-	1020	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	167	-	pF
$Q_g$	Total Gate Charge	$V_{DS}=15V, I_D=24A,$ $V_{GS}=10V$	-	82	-	nC
$Q_{gs}$	Gate-Source Charge		-	14	-	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	15	-	nC
<b>Switching Characteristics</b> <sup>b</sup>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=15V,$ $I_D=15A, R_{GEN}=3.3\Omega,$ $V_{GS}=10V$	-	15.6	-	ns
$t_r$	Turn-on Rise Time		-	23.5	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	62.8	-	ns
$t_f$	Turn-off Fall Time		-	15.2	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current		-	-	120	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	314	A
$V_{SD}^a$	Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S=20A$	-	-	1.2	V
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=30A, dI/dt=100A/\mu s$	-	57	-	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge		-	71	-	nC

Notes :

a : Pulse test ; pulse width  $\leq 300 \mu s$ , duty cycle  $\leq 2 \%$ 

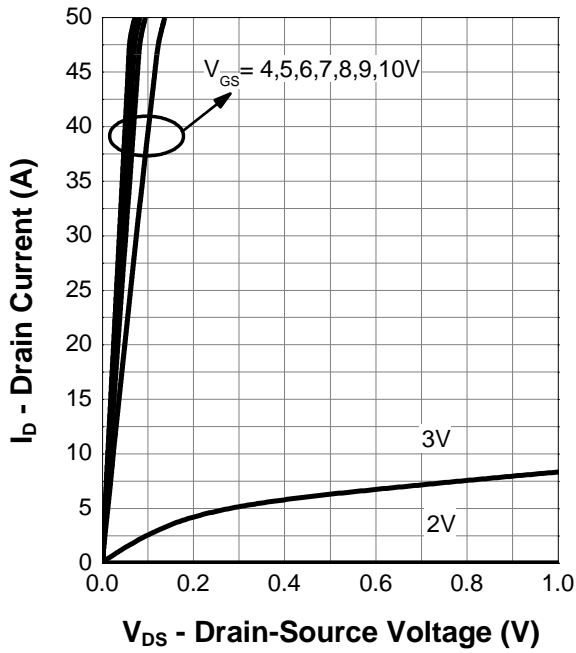
b : Guaranteed by design, not subject to production testing

Typical Characteristics (Cont.)

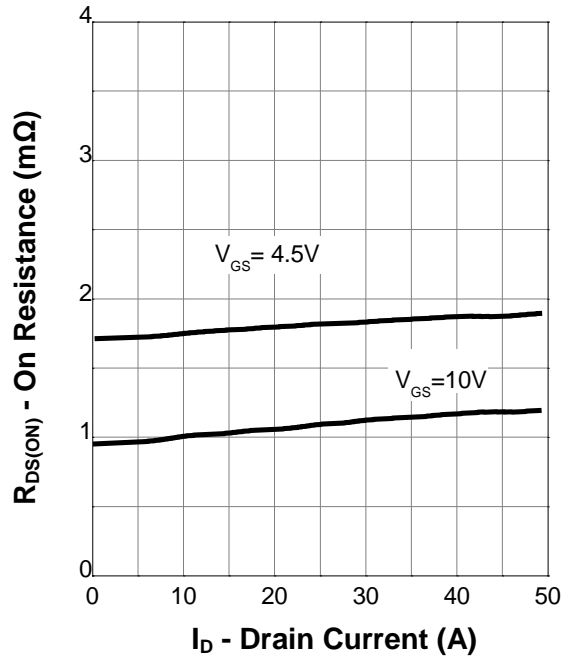


Typical Characteristics ( Cont.)

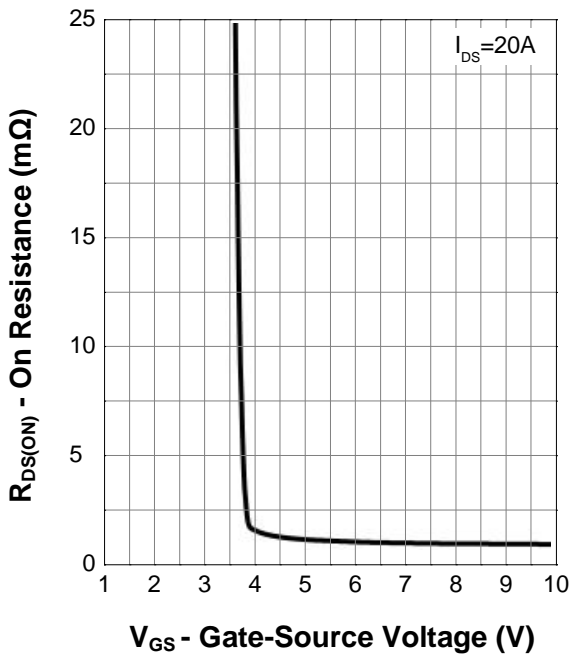
Output Characteristics



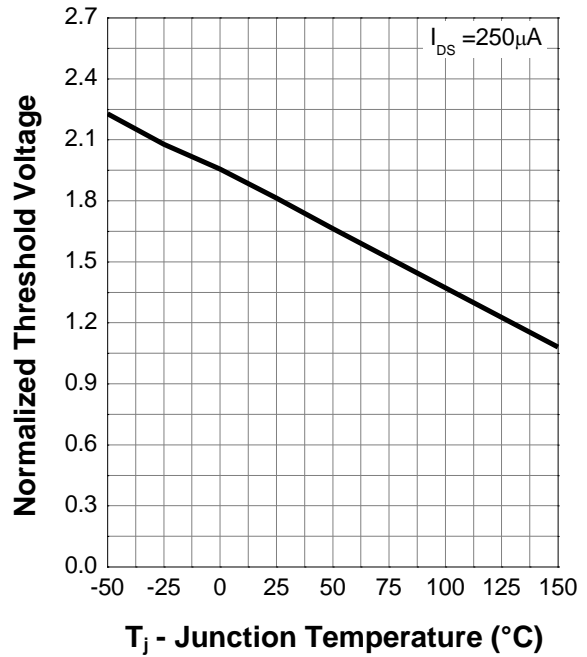
On Resistance



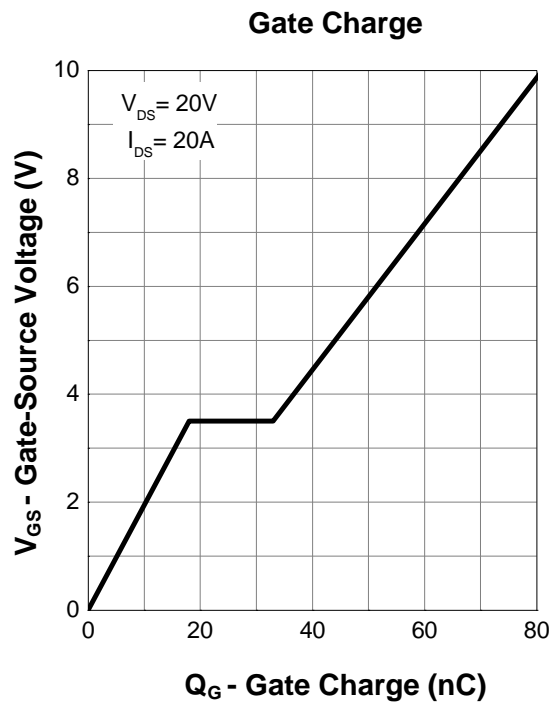
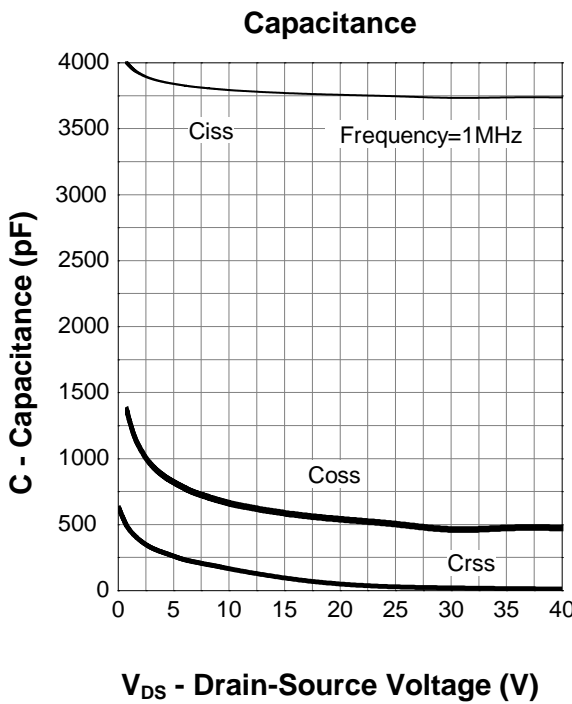
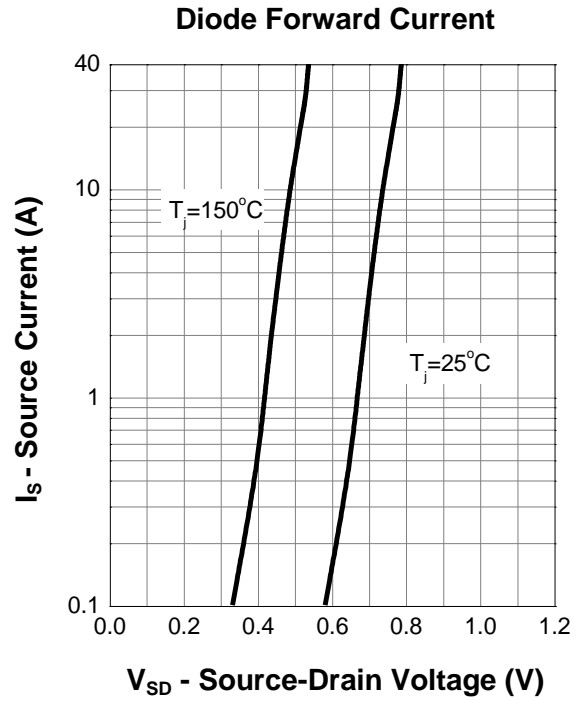
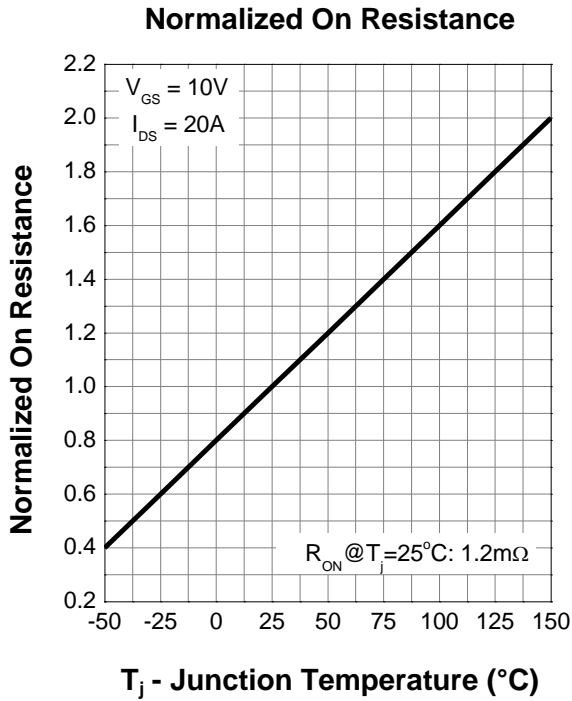
Transfer Characteristics



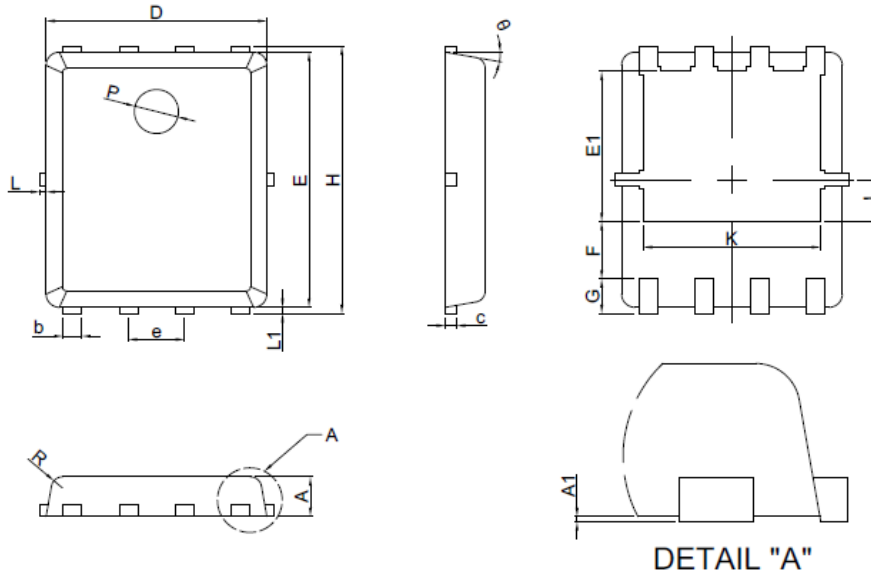
Normalized Threshold Voltage



Typical Characteristics ( Cont.)



Package Dimensions : PDFN5x6-8L



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	0.80	1.00
A1	0.00	0.05
b	0.35	0.49
c	0.254REF	
D	4.90	5.10
F	1.40REF	
E	5.70	5.90
e	1.27BSC	
H	5.95	6.20
L1	0.10	0.18
G	0.60REF	
K	4.00REF	
L	-	0.15
J	0.95BSC	
P	1.00REF	
E1	3.40REF	
theta	6°	14°
R	0.25REF	

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